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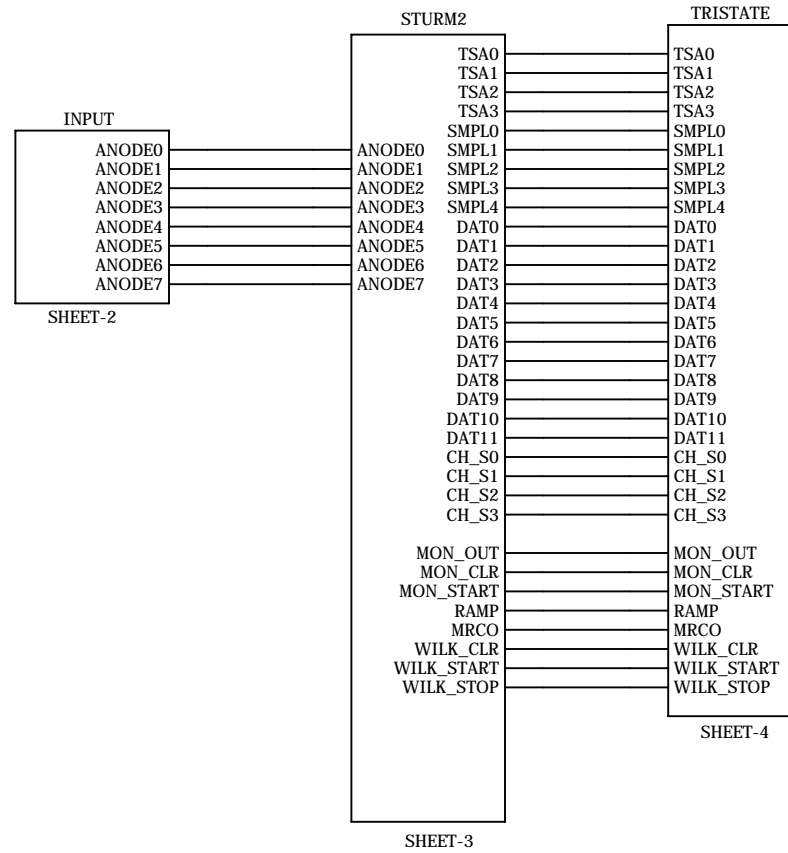
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As Built

Layer Definitions

- Top Copper routing
- Layer 2 split GND
- Layer 3 split 5V/+A2.5V
- Bottom Copper split Vped/routing

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TITLE: IDL_10_024_DC_STURM2_RevA



Design:
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SHEET: 1 OF 5

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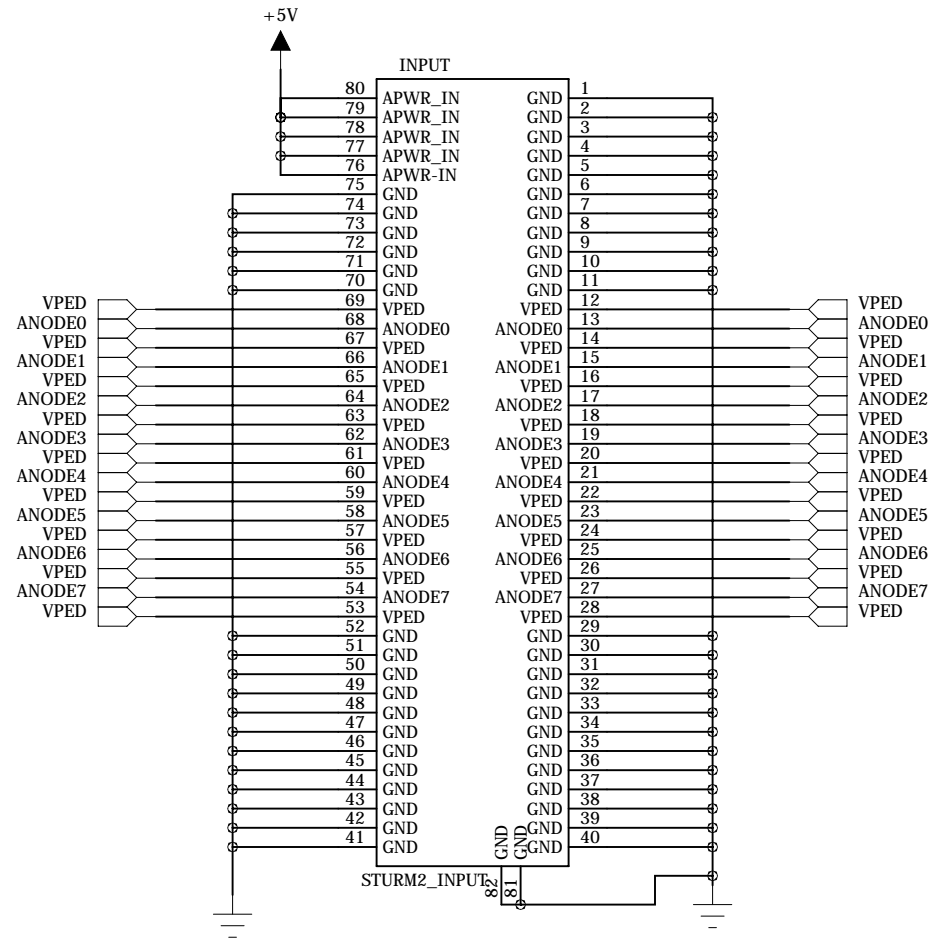
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TITLE: IDL_10_024_DC_STURM2_RevA



Design:

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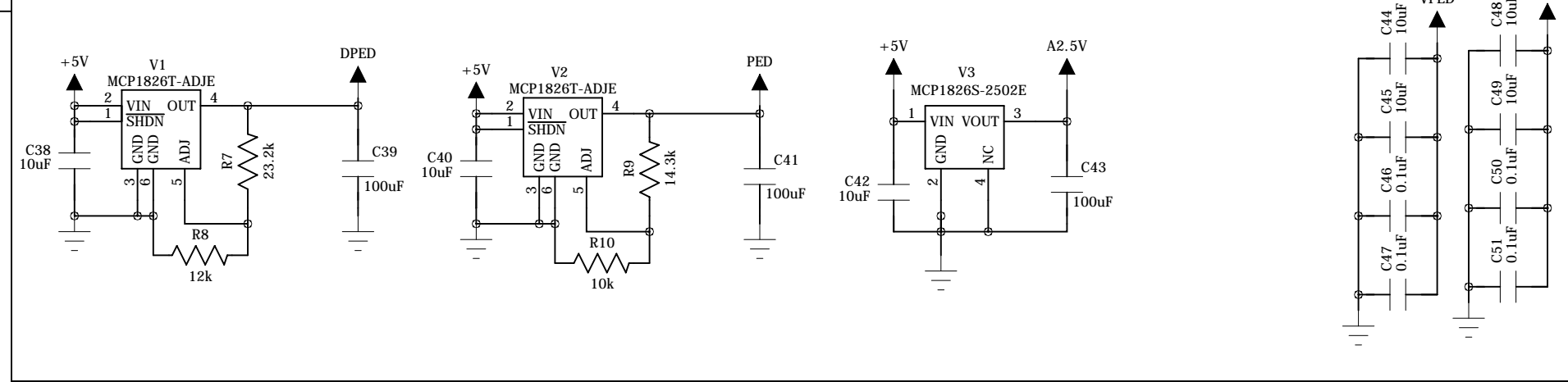
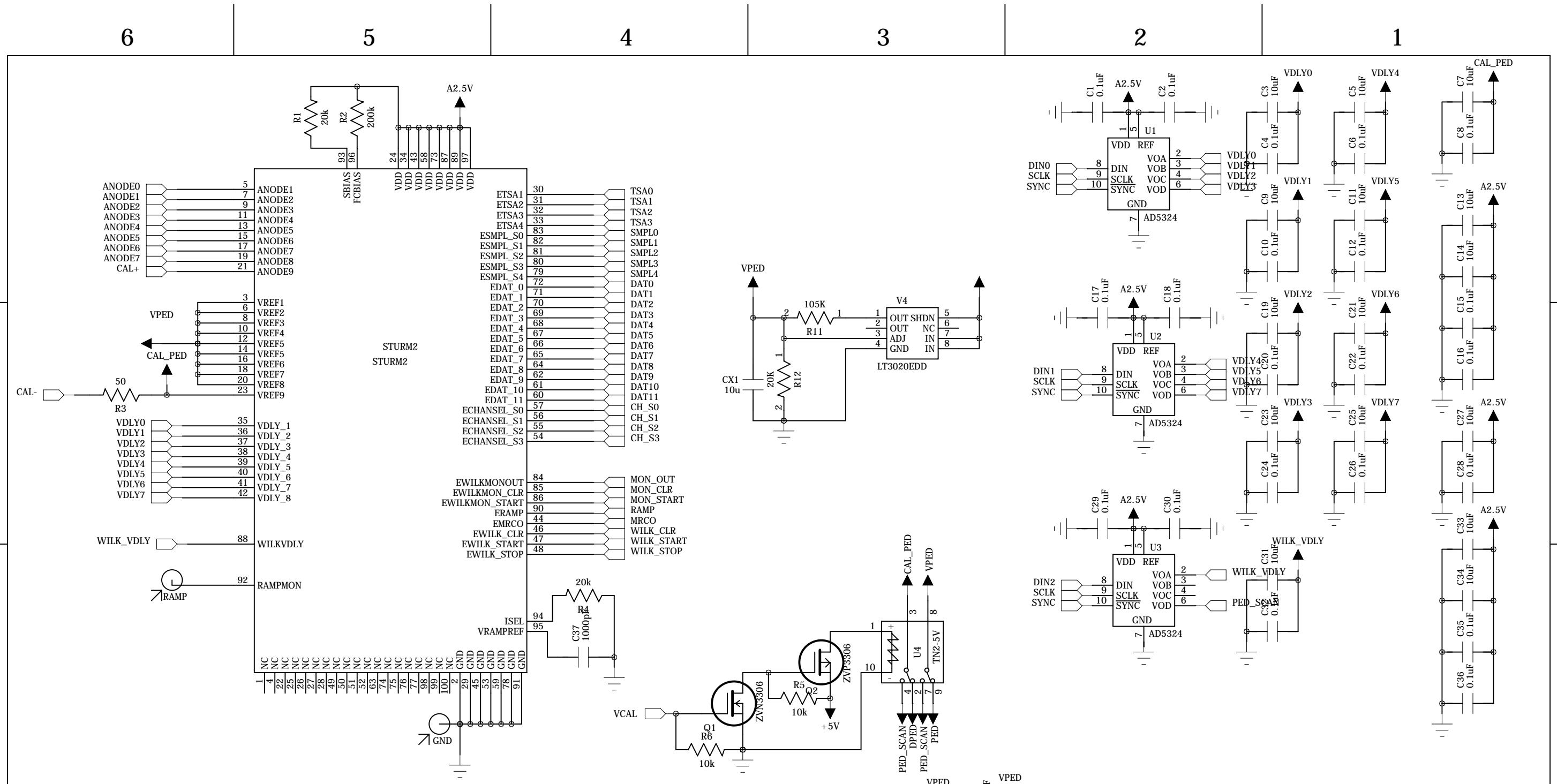
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SHEET: 2 OF 5



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TITLE: IDL_10_024_DC_STURM2_RevA

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DATED: MAY-2011 [STURM2] SHEET: 3 OF 5

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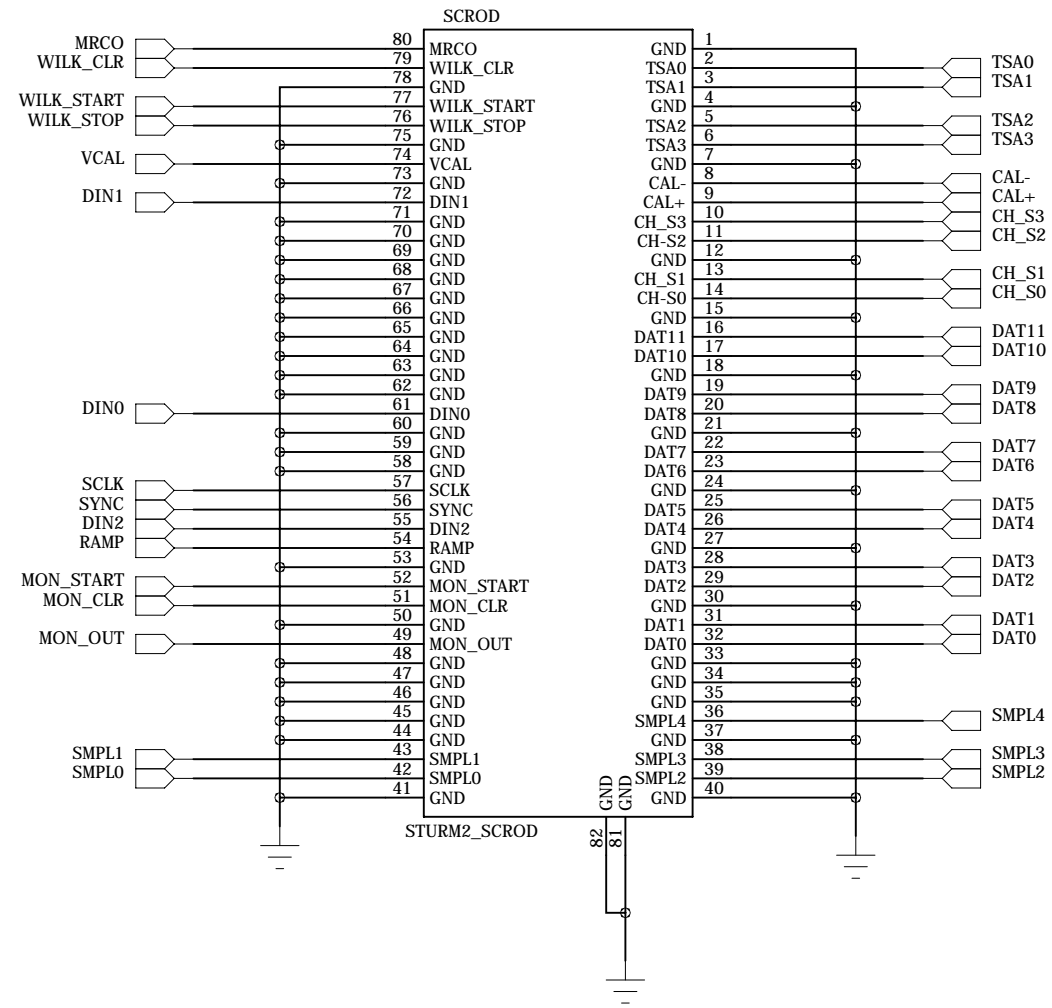
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 TITLE: IDL_10_024_DC_STURM2_RevA

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